

60V 175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI3333-8

Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _C = +25°C
	20.5mΩ @ V _{GS} = 10V	24.5A
60V	27mΩ @ V _{GS} = 4.5V	21.5A

Description and Applications

This new generation N-channel enhancement mode MOSFET is designed to minimize $R_{\text{DS}(\text{ON})}$ yet maintain superior switching performance. This device is ideal for use in power management and load switch.

- · Wireless Charging
- DC-DC Converters
- Power Management

Features and Benefits

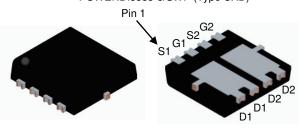
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Ensures On-State Losses are Minimized
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Wettable Flank for Improved Optical Inspection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

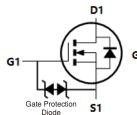
Mechanical Data

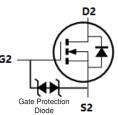
- Case: POWERDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.072 grams (Approximate)

POWERDI3333-8/SWP (Type UXD)









Top View

Bottom View

Internal Schematic

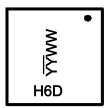
Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH6015LDVW-7	POWERDI3333-8/SWP (Type UXD)	2,000/Tape & Reel
DMTH6015LDVW-13	POWERDI3333-8/SWP (Type UXD)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at \ https://www.diodes.com/design/support/packaging/diodes-packaging/.$

Marking Information



H6D= Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 21 = 2021)

WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	60	V
Gate-Source Voltage			V _{GSS}	±16	V
Continuous Drain Current Vos – 10V (Note 6)		Tc = +25°C	ID	24.5	А
		Tc = +100°C		17.4	
Continuous Proin Comment V 10V (Note C)	Steady	T _A = +25°C	ID	9.2	А
Continuous Drain Current, V _{GS} = 10V (Note 6)	State	T _A = +100°C		6.5	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	98	Α
Maximum Continuous Body Diode Forward Current (Note 6)			Is	3	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			Ism	98	Α
Avalanche Current, L = 0.1mH			las	20.4	Α
Avalanche Energy, L = 0.1mH			Eas	20.8	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.46	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	103	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P_{D}	3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	50	°C/W
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	7	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

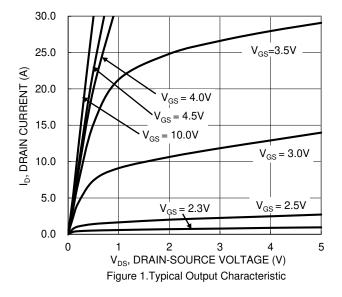
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

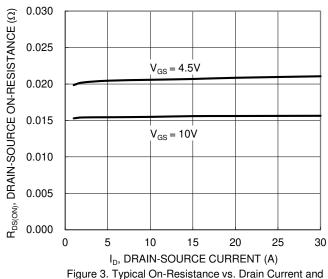
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)					•		
Drain-Source Breakdown Voltage	BVDSS	60			V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	-	_	1	μΑ	$V_{DS} = 48V$, $V_{GS} = 0V$	
Gate-Source Leakage	Igss		_	±10	μΑ	$V_{GS} = \pm 16V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1.3		2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	J	-	15.6	20.5	mΩ	VGS = 10V, ID = 10A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	21	27	11177	VGS = 4.5V, ID = 6A	
Diode Forward Voltage	VsD	_	0.7	1.2	V	Vgs = 0V, Is = 1A	
DYNAMIC CHARACTERISTICS (Note 8)						•	
Input Capacitance	Ciss	_	825		pF	.,	
Output Capacitance	Coss	-	244		pF	V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Reverse Transfer Capacitance	Crss	_	20.5	_	pF	I = IIVIDZ	
Gate Resistance	Rg	_	1.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (VGS = 4.5V)	Qg	_	7.1	_	nC		
Total Gate Charge (VGS = 10V)	Qg	_	14.3	_	nC	\	
Gate-Source Charge	Q_{gs}	_	2.1	_	nC	V _{DS} = 30V, I _D = 10A	
Gate-Drain Charge	Q _{gd}	_	2.8	_	nC	1	
Turn-On Delay Time	tD(ON)	_	4.0	_	ns		
Turn-On Rise Time	t _R	_	5.3	_	ns	$\begin{split} V_{GS} &= 10 \text{V}, \ V_{DS} = 30 \text{V}, \\ R_g &= 6 \Omega, \ I_D = 10 \text{A} \end{split}$	
Turn-Off Delay Time	tD(OFF)	_	18.5		ns		
Turn-Off Fall Time	tF		8.0		ns		
Body Diode Reverse Recovery Time	trr	_	22.7		ns	L 0.0 -11/-14 - 4.00.0 /	
Body Diode Reverse Recovery Charge	Qrr	_	12.8		nC	$I_F = 6A$, $di/dt = 100A/\mu s$	

5. Device mounted on FR-4 PCB, with minimum recommended pad layout, single sided.

- Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.







Gate Voltage

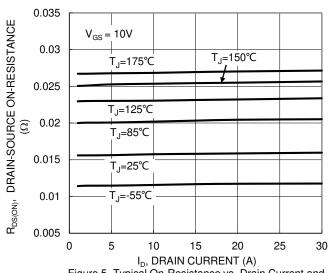


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

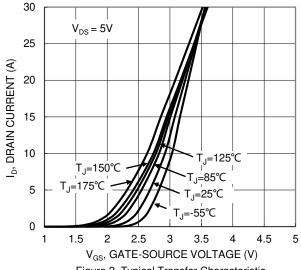


Figure 2. Typical Transfer Characteristic

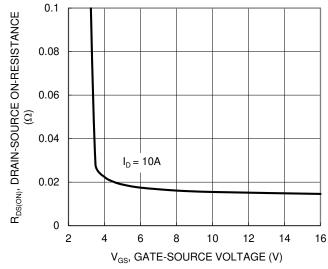


Figure 4. Typical Transfer Characteristic

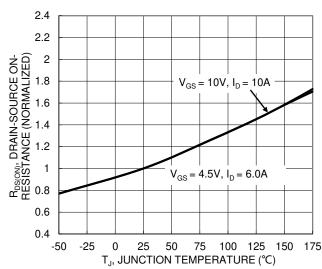


Figure 6. On-Resistance Variation with Temperature





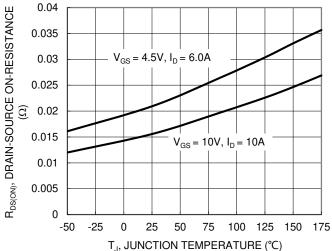


Figure 7. On-Resistance Variation with Temperature

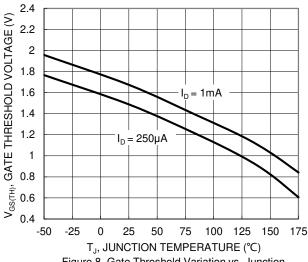


Figure 8. Gate Threshold Variation vs. Junction Temperature

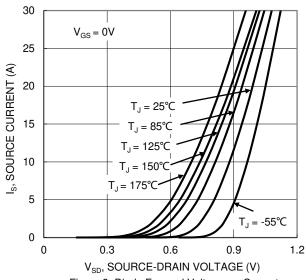
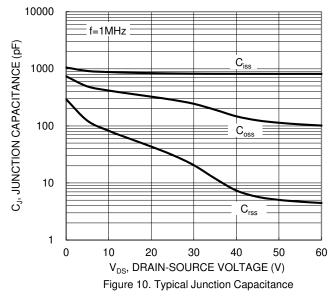
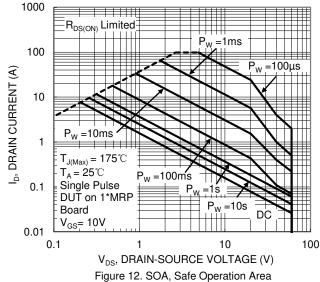


Figure 9. Diode Forward Voltage vs. Current



 $V_{DS} = 30V$, $I_D = 10A$ 15



10

8

6

4

2

0

0

5

10

Qg (nC)

Figure 11. Gate Charge

 $V_{GS}(V)$



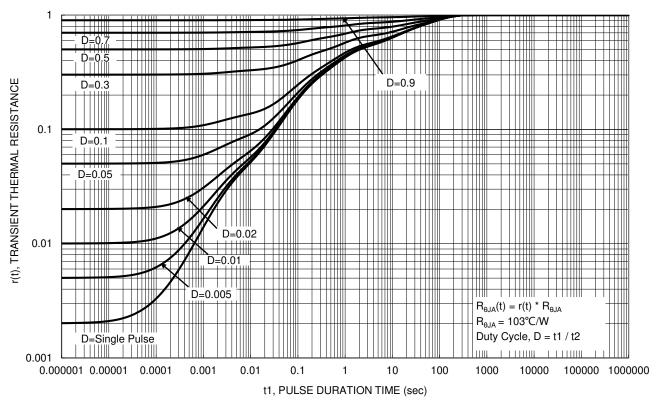


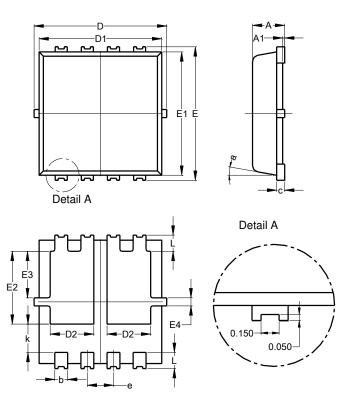
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI®3333-8/SWP (Type UXD)

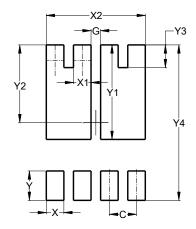


POWERDI®3333-8/SWP						
(Type UXD)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	-			
b	0.25	0.40	0.32			
С	0.10	0.25	0.15			
D	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	1.00	1.20	1.10			
Е	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	1.60	2.00	1.80			
E3	0.95	1.35	1.15			
E4	0.10	0.30	0.20			
е	_	_	0.65			
L	0.30	0.50	0.40			
k	0.50	0.90	0.70			
а	0°	12°	10°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI®3333-8/SWP (Type UXD)



Dimensions	Value (in mm)		
C	0.650		
G	0.230		
X	0.420		
X1	0.420		
X2	2.370		
Y	0.700		
Y1	2.250		
Y2	1.850		
Y3	0.540		
Y4	3.700		



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